

Appl. No. 10/840,095  
Amdt. dated 01/13/2007  
Response to Office Action of 10/17/2006

Attorney Docket No.: N1085-00288  
[TSMC2004-0032]

**Amendments to the Specification:**

Please replace the title with the following amended title:

**COPPER PLATING OF SEMICONDUCTOR DEVICES USING SINGLE  
INTERMEDIATE LOW POWER IMMERSION STEP**